

CHIPS ACT OVERVIEW

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THE CHALLENGES FACING U.S. SEMICONDUCTOR SUPPLY CHAINS

SEMICONDUCTORS ARE CRITICAL FOR U.S. NATIONAL SECURITY & THE ECONOMY



Quantum Computing

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Artificial Intelligence



Autonomous Systems

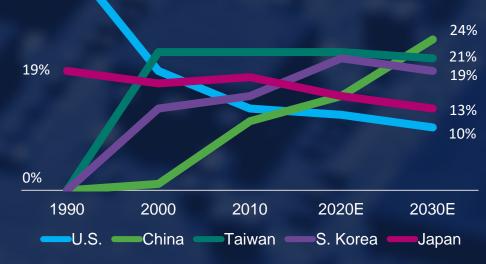


Space & Hypersonics Cyber Security

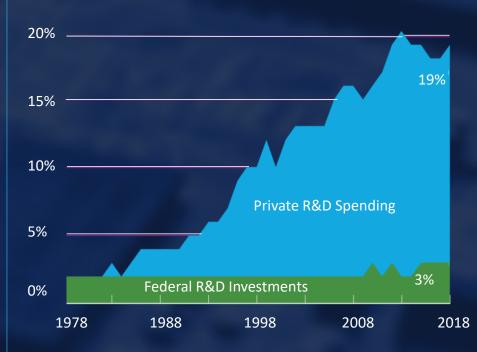


U.S. SHARE OF CHIP MANUFACTURING IS ERODING WHILE ASIA'S HAS GROWN TO 77% OF GLOBAL CAPACITY DUE TO GOVERNMENT INVESTMENT





FEDERAL SEMICONDUCTOR RESEARCH FUNDING NOT KEEPING PACE WITH NEEDS



U.S. share of global semiconductor manufacturing capacity has declined from 37% in 1990 to 12% today.

Cost to build and operate a fab in the US 25-50% more expensive than alternative locations abroad due to the lack of government incentives.

GLOBAL GOVERNMENT INCENTIVES FOR SEMICONDUCTOR RESEARCH, MANUFACTURING & DESIGN



U.S. CHIPS & SCIENCE ACT OF 2022

Creating Helpful Incentives for Producing Semiconductors for America Advanced Manufacturing Investment Tax Credit

PROGRAM	Program Subtotal	OVERVIEW
Semiconductor Manufacturing Incentives Department of Commerce	\$39 billion over 5 years (Includes \$2B for legacy semiconductors)	 25% investment tax credit for "advanced manufacturing facility": semiconductor manufacturing semiconductor manufacturing equipment Election for payment against tax Subject to recapture for material expansions
Semiconductor Research Programs Department of Commerce	\$11 billion over 5 years	
Workforce Development National Science Foundation	\$0.2 billion over 5 years	
		in countries of concern
CHIPS Defense Fund Department of Defense	\$2 billion over 5 years	Timing – property placed in service after
International Technology Security Fund Department of State	\$0.5 billion over 5 years	12/31/2022 and for which construction begins prior to 1/1/2027
Appropriated Tot \$52.7B	al Funds "to remain available until expended"	CBO Revenue Estimate \$24.3B

CHIPS ACT IMPLEMENTATION

Eligibility

- Semiconductor manufacturing/research/ packaging, and semiconductor equipment and materials
- Construction, expansion, or modernization
- Located in the U.S., and not a re-location

Conditions

- Restrictions on use of funding permissible uses of funds, no stock buybacks or payment of dividends
- Clawback missed project deadlines, certain expansions of facilities in China or other countries of concern for 10 years (exception for facilities that produce legacy semiconductors)

Considerations for Awards

- Address gaps and vulnerabilities in supply chain
- Address national security needs
- Address needs of key customers critical industries
- Jobs and community investment
- Workforce development
- Commercial viability of projects

Other/Questions

- Timing for issuance of incentives
- Weighting of factors
- Mix of projects fabs, equipment, materials
- Amounts of awards
- Interaction with Advanced Manufacturing Investment Credit
- Environmental review and permitting (NEPA, etc.)

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RESEARCH PROGRAM APPROPRIATIONS

Commerce

DoD

National Semiconductor Technology Center

Structured as public-private consortium in coordination

Work with DOL & universities to expand post-secondary

with DOE and NSF

education

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National Advanced Packaging Manufacturing Program

- Coordinate with NSTC and Manufacturing USA Institutes
- Funding merged with NSTC after first year

Commerce

National Network for Microelectronics R&D

- Implemented by the Dept. of Defense to transition R&D innovations into workable technologies
- DoD Commons program may fulfill this requirement

Manufacturing USA Institutes

Establish up to 3 centers to research automation of semiconductor machinery, advanced ATP capabilities, and the development/deployment of skills training

NIST

No appropriations for DOE research in CHIPS

S I A **CHIPS IMPLEMENTATION – BIDEN PRIORITIES** Executive Order 14080 (8/25/22) outlines admin objectives, direction, and strategy Meet economic & Protect taxpayer national security dollars needs **CHIPS Implementation** Generate benefits for **Ensure long-term Steering Council** a broad range of leadership in the stakeholders & Co-Chairs: National Economic Director Deese, National Security sector Advisor Sullivan, Acting OSTP Director Nelson communities 13 additional members from the administration Strengthen & expand Catalyze private sector regional manufacturing and investment innovation clusters

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